



WIRE BOND PAD / CONNECTOR PIN INTERCONNECTION PLAN

W/B NO.	PIN NO.	W/B NO.	PIN NO.
1	1	18	10
2	2	19	11
3	3	20	12
4	4	21	23
5	5	22	25
6	22	23	26
7	13	24	18
8	14	25	19
9	32(VCC)	26	32(VCC)
10	16(VSS)	27	16(VSS)
11	15	28	20
12	17	29	21
13	29	30	24
14	6	31	27
15	7	32	28
16	8	33	30
17	9	34	31

BONDING PATTERN

MODIFICATION					NAME	TOLERANCE	DRAWN	CHECKED	APPROVED	DATE
					32 LEAD FLAT PACKAGE	UNLESS OTHERWISE SPECIFIED	S. K	M. K/S. F	T. A	JUL. 04. '97
					SCALE 10 / 1	MATERIAL				
	REDRAWN	DEC. 10. '96	Y. T. Y. M.	M. K. S. F.	T. A.	THIRD ANGLE PROJECTION				
	CHANGED	DATE	DRAWN	CHECKED	APPROVED	KYOCERA	KYOCERA CORPORATION KYOTO JAPAN		DRAWING NO.	SHEET
							KD-F97742-C		2/8	



